



# Product Change Notification



Product Group: OPT/Mon Sep 19, 2022/PCN-OPT-1234-2022-REV-0

## Changes of materials for TFDU4301

**DESCRIPTION OF CHANGE:** -Introduction of a new in-house designed IRDC IC. The Chaldene IC provides 20 percent longer distance (in meters) and improved ESD robustness from current 1kV to 2kV.

-Introduction of a new Surface Emitting Technology Chip.

-Changeover of the Au wire Diameter from 30um to 25um.

We recommend to test the product in customers application.

**REASON FOR CHANGE:** - New IC:

The existing external IC Supplier will end the production. In order to assure a long-term product availability of IRDC products, Vishay developed an inhouse IC in cooperation with the worlds leading Chip Foundry.

-New Emitter Chip:

Changeover to latest Surface Emitting Technology to assure long-term product availability.

-Au wire Diameter reduction:

In order to streamline the production and optimize the material supply chain, Vishay introduces a new Standardization of Au wire Diameter. The material is qualified to high Standards.

**EXPECTED INFLUENCE ON QUALITY/RELIABILTY/PERFORMANCE:** No change on Quality/Reliability. Similar electrical and optical characteristics.

**PART NUMBERS/SERIES/FAMILIES AFFECTED:** Please see materials list on the succeeding page.

**VISHAY BRAND(s):** Vishay Semiconductors

**TIME SCHEDULE:**

Start Shipment Date: Sun Jan 1, 2023

**SAMPLE AVAILABILITY:** 25-Sep-2022

**PRODUCT IDENTIFICATION:** via date code

**QUALIFICATION DATA:** Q-Report is availablw in ww40.

**This PCN is considered approved, without further notification, unless we receive specific customer concerns before Sun Nov 13, 2022 or as specified by contract.**

**ISSUED BY:** Rainer Hauschildt, rainer.hauschildt@vishay.com

**For further information, please contact your regional Vishay office.**

**CONTACT INFORMATION:**

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ONE OF THE WORLD'S LARGEST MANUFACTURERS OF DISCRETE SEMICONDUCTORS AND PASSIVE COMPONENT



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?TFDU4301-TR1	TFDU4301-TR3	TFDU4301-TT1	TFDU4301-TT3	TFDU4301D-TT3
TFDU4301E-TR1	TFDU4301E-TR3	TFDU4301E-TT3		

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## Changes of materials for TFDU4301

Vishay Opto has published PCN-OPT-1234-2022, announcing the introduction of a new IC, a new Surface Emitter Chip and the usage of standardized 25µm Bond wires for the existing TFDU4301x IRDC Transceiver Series.

### FAQ:

Q: Are there any technical differences (form/fit/function) expected?

A: Mechanically there are no changes.

Electrically/Optically the performance of the Transmitter changes in the following way.

#### Before material changes:

ELECTRICAL CHARACTERISTICS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , $V_{CC1} = V_{CC2} = 2.4\text{ V to }5.5\text{ V}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>TRANSCEIVER</b>						
Supply voltage		$V_{CC1}$	2.4	-	5.5	V
Operating temperature range		$T_{amb}$	-30	-	+85	$^{\circ}\text{C}$
Data rates			9.6	-	115.2	kbit/s
Idle supply current at $V_{CC1}$ (receive mode, no signal)	SD = low, $T_{amb} = -25\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ independent of ambient light, $V_{CC1} = V_{CC2} = 2.4\text{ V to }5.5\text{ V}$	$I_{CC1}$	40	70	150	$\mu\text{A}$
	SD = low, $T_{amb} = 25\text{ }^{\circ}\text{C}$ , $V_{CC1} = V_{CC2} = 2.4\text{ V to }5.5\text{ V}$	$I_{CC1}$	40	70	100	$\mu\text{A}$
Average dynamic supply current, transmitting	$I_{IRED} = 300\text{ mA}$ , 20 % duty cycle	$I_{CC1}$	-	0.6	2	mA
Standby (SD) (1) supply current	SD = high, $T_{amb} = -25\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ independent of ambient light	$I_{SD}$	-	0.01	1	$\mu\text{A}$
RXD to $V_{CC1}$ impedance		$R_{RXD}$	400	500	600	k $\Omega$
Input voltage low (TXD, SD)	SD = high	$V_{ILO}$	-0.3	-	0.4	V
Input voltage high (SD)	For compliance with ISD spec.	$V_{IHI}$	$V_{CC1} - 0.3$	-	6	V
Input voltage high (TXD)		$V_{IHI}$	$V_{CC1} - 0.5$	-	6	V
Timing logic decision level			-	$0.5 \times V_{CC1}$	-	
Input leakage current low	$V_{ILO} \leq 0.3\text{ V}$	$I_{ILO}$	-	0.01	10	$\mu\text{A}$
Input leakage current high	$V_{IHI} \geq V_{CC1} - 0.3\text{ V}$	$I_{IHI}$	-	0.01	10	$\mu\text{A}$
Input capacitance (TXD, SD)		$C_{IN}$	-	-	5	pF
Output voltage low, RXD	$C_{load} = 8\text{ pF}$ , $I_{OLo} \leq [+500\text{ }\mu\text{A}]$	$V_{OLO}$	-	-	0.4	V
Output voltage high, RXD	$I_{OH} = -200\text{ }\mu\text{A}$	$V_{OHI}$	$0.8 \times V_{CC1}$	-	$V_{CC1}$	V



OPTOELECTRONIC CHARACTERISTICS (T <sub>amb</sub> = 25 °C, V <sub>CC1</sub> = V <sub>CC2</sub> = 2.4 V to 5.5 V unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>RECEIVER</b>						
Minimum irradiance E <sub>a</sub> In angular range <sup>(2)</sup>	9.6 kbit/s to 115.2 kbit/s, λ = 850 nm to 900 nm; α = 0°, 15°	E <sub>e</sub>	-	40 (4)	80 (8)	mW/m <sup>2</sup> (μW/cm <sup>2</sup> )
Maximum irradiance E <sub>a</sub> In Angular Range <sup>(3)</sup>	λ = 850 nm to 900 nm	E <sub>e</sub>	-	5 (500)	-	kW/m <sup>2</sup> (mW/cm <sup>2</sup> )
Maximum no detection irradiance <sup>(1)</sup>	λ = 850 nm to 900 nm, t <sub>r</sub> , t <sub>f</sub> < 40 ns, t <sub>po</sub> = 1.6 μs at f = 115 kHz, no output signal allowed	E <sub>e</sub>	4 (0.4)	-	-	mW/m <sup>2</sup> (μW/cm <sup>2</sup> )
Rise time of output signal	10 % to 90 %, C <sub>L</sub> = 8 pF	t <sub>r(FXDI)</sub>	10	30	80	ns
Fall time of output signal	90 % to 10 %, C <sub>L</sub> = 8 pF	t <sub>f(FXDI)</sub>	10	30	80	ns
RXD pulse width of output signal	Input pulse length > 1.2 μs	t <sub>PW</sub>	1.7	2.2	3	μs
Stochastic jitter, leading edge	Input irradiance = 100 mW/m <sup>2</sup> , ≤ 115.2 kbit/s		-	-	350	ns
Standby/shutdown delay, receiver startup time	After shutdown active or power-on		-	100	500	μs
Latency		t <sub>L</sub>	-	50	150	μs
<b>TRANSMITTER (new surface emitter values introduced via PCN OPT-1210-2022)</b>						
IRED operating current limitation	No external resistor for current limitation <sup>(4)</sup>	I <sub>D</sub>	200	300	430	mA
Forward voltage of built-in IRED	I <sub>f</sub> = 300 mA	V <sub>f</sub>	1.4	1.8	1.9	V
Output leakage IRED current	TXD = 0 V, 0 < V <sub>CC1</sub> < 5.5 V	I <sub>IRED</sub>	-1	0.01	1	μA
Output radiant intensity	α = 0°, 15°, TXD = high, SD = low V <sub>CC1</sub> = 5 V, α = 0°, 15°, TXD = low or SD = high (receiver is inactive as long as SD = high)	I <sub>e</sub>	50	200	400	mW/sr
Output radiant intensity, angle of half intensity		α	-	± 30	-	°
Peak - emission wavelength <sup>(5)</sup>		λ <sub>p</sub>	870	-	910	nm
Spectral bandwidth		Δλ	-	45	-	nm
Optical rise time, fall time		t <sub>ropt</sub> , t <sub>fopt</sub>	10	50	100	ns
Optical output pulse duration	Input pulse width 1.6 < t <sub>TXD</sub> < 23 μs	t <sub>opt</sub>	t <sub>TXD</sub> - 0.15	-	t <sub>TXD</sub> + 0.15	μs
	Input pulse width t <sub>TXD</sub> ≥ 23 μs	t <sub>opt</sub>	23	50	100	μs
Optical overshoot			-	-	25	%

After material changes:

ELECTRICAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, V <sub>CC1</sub> = V <sub>CC2</sub> = 2.4 V to 5.5 V unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>TRANSCEIVER</b>						
Supply voltage		V <sub>CC1</sub>	2.4	-	5.5	V
Operating temperature range		T <sub>amb</sub>	-25	-	+85	°C
Data rates			9.6	-	115.2	kbit/s
Idle supply current at V <sub>CC1</sub> (receive mode, no signal)	SD = low, T <sub>amb</sub> = -25 °C to +85 °C independent of ambient light, V <sub>CC1</sub> = V <sub>CC2</sub> = 2.4 V to 5.5 V	I <sub>CC1</sub>	40	70	110	μA
Average dynamic supply current, transmitting	I <sub>IRED</sub> = 300 mA, 20 % duty cycle	I <sub>CC1</sub>	-	0.6	2	mA
Standby (SD) <sup>(1)</sup> supply current	SD = high, T <sub>amb</sub> = -25 °C to +85 °C independent of ambient light	I <sub>SD</sub>	-	0.01	1	μA
RXD to V <sub>CC1</sub> impedance	SD = high	R <sub>RXD</sub>	400	500	600	kΩ
Input voltage low (TXD, SD)		V <sub>ILo</sub>	-0.3	-	0.4	V
Input voltage high (SD)	For compliance with ISD spec.	V <sub>Hi</sub>	V <sub>CC1</sub> - 0.3	-	6	V
Input voltage high (TXD)		V <sub>Hi</sub>	V <sub>CC1</sub> - 0.5	-	6	V
Timing logic decision level			-	0.5 x V <sub>CC1</sub>	-	
Input leakage current low	V <sub>ILo</sub> ≤ 0.3 V	I <sub>ILo</sub>	-	0.01	10	μA
Input leakage current high	V <sub>Hi</sub> ≥ V <sub>CC1</sub> - 0.3 V	I <sub>Hi</sub>	-	0.01	10	μA
Input capacitance (TXD, SD)		C <sub>IN</sub>	-	-	5	pF
Output voltage low, RXD	C <sub>load</sub> = 8 pF, I <sub>OLo</sub> ≤ +500 μA	V <sub>OLo</sub>	-	-	0.15 x V <sub>CC1</sub>	V
Output voltage high, RXD	I <sub>OHi</sub> = 200 μA	V <sub>OHi</sub>	0.8 x V <sub>CC1</sub>	-	-	V



<b>OPTOELECTRONIC CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , $V_{CC1} = V_{CC2} = 2.4\text{ V to } 5.5\text{ V}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>RECEIVER</b>						
Minimum irradiance $E_e$ in angular range <sup>(2)</sup>	9.6 kbit/s to 115.2 kbit/s, $\lambda = 850\text{ nm to } 900\text{ nm}$ ; $\alpha = 0^{\circ}, 15^{\circ}$	$E_e$	-	20	50	mW/m <sup>2</sup>
Maximum irradiance $E_e$ in Angular Range <sup>(3)</sup>	$\lambda = 850\text{ nm to } 900\text{ nm}$	$E_e$	2	5	-	kW/m <sup>2</sup>
Maximum no detection irradiance <sup>(1)</sup>	$\lambda = 850\text{ nm to } 900\text{ nm}$ , $t_r, t_f < 40\text{ ns}$ , $t_{pd} = 1.6\text{ }\mu\text{s}$ at $f = 115\text{ kHz}$ , no output signal allowed	$E_e$	4 (0.4)	-	-	mW/m <sup>2</sup> ( $\mu\text{W}/\text{cm}^2$ )
Rise time of output signal	10 % to 90 %, $C_L = 8\text{ pF}$	$t_{r(FRXD)}$	10	30	80	ns
Fall time of output signal	90 % to 10 %, $C_L = 8\text{ pF}$	$t_{f(FRXD)}$	10	30	80	ns
RXD pulse width of output signal	Input pulse length $> 1.2\text{ }\mu\text{s}$	$t_{PW}$	1.7	2.2	3	$\mu\text{s}$
Stochastic jitter, leading edge	Input irradiance = $100\text{ mW}/\text{m}^2$ , $\leq 115.2\text{ kbit/s}$		-	-	350	ns
Standby/shutdown delay, receiver startup time	After shutdown active or power-on		-	100	500	$\mu\text{s}$
Latency		$t_L$	-	50	150	$\mu\text{s}$
<b>TRANSMITTER</b>						
IRED operating current limitation	No external resistor for current limitation <sup>(4)</sup>	$I_D$	200	300	430	mA
Forward voltage of built-in IRED	$I_f = 300\text{ mA}$	$V_f$	1.4	1.8	1.9	V
Output leakage IRED current	TXD = 0 V, $0 < V_{CC1} < 5.5\text{ V}$	$I_{IRED}$	-1	0.01	1	$\mu\text{A}$
Output radiant intensity	$\alpha = 0^{\circ}, 15^{\circ}$ , TXD = high, SD = low	$I_e$	50	200	400	mW/sr
	$V_{CC1} = 5\text{ V}$ , $\alpha = 0^{\circ}, 15^{\circ}$ , TXD = low or SD = high (receiver is inactive as long as SD = high)	$I_e$	-	-	0.04	mW/sr
Output radiant intensity, angle of half intensity		$\alpha$	-	$\pm 30$	-	$^{\circ}$
Peak - emission wavelength <sup>(5)</sup>		$\lambda_p$	870	-	910	nm
Spectral bandwidth		$\Delta\lambda$	-	45	-	nm
<b>TRANSMITTER</b>						
Optical rise time, fall time		$t_{ropt}, t_{fopt}$	10	50	100	ns
Optical output pulse duration	Input pulse width $1.6 < t_{TXD} < 23\text{ }\mu\text{s}$	$t_{opt}$	$t_{TXD} - 0.15$	-	$t_{TXD} + 0.15$	$\mu\text{s}$
	Input pulse width $t_{TXD} \geq 23\text{ }\mu\text{s}$	$t_{opt}$	23	50	100	$\mu\text{s}$
Optical overshoot			-	-	25	%

Q: Are datasheets with these new values available?

A: Datasheets of the new TFDU4301 are available on the Vishay's website: [IRDC Transceivers | Vishay](#) . The header of the new datasheet states:

**Datasheet Values Refer to PCN-OPT-1234-2022**

Q: When do we plan to implement the new materials in production?

A: 01-Jan-2023.

Q: How can the customer distinguish products using existing materials or new materials?

A: The PCN announces a changeover date. This changeover date will be mentioned on the standard bar code labels as shown below (Batch 202222PH19→ produced in ww22 2022). Besides a green Sticker will be added to the box label only for products using new materials.





Q: Why has Vishay introduced these changes?

A: -New IC:

The existing external IC Supplier will end the production. In order to assure a long-term product availability of IRDC products, Vishay developed an inhouse IC in cooperation with the worlds leading Chip Foundry.

-New Emitter Chip:

Changeover to latest Surface Emitting Technology to assure long-term product availability.

-Au wire Diameter reduction:

In order to streamline the production and optimize the material supply chain, Vishay introduces a new Standardization of Au wire Diameter. The material is qualified to high Standards.

Q: Are there any technical advantages of the new materials?

A: Yes. The new generation of Chips offer longer link distance, improved ESD robustness, and a wider operating voltage.

Q: Are samples of the new TFDU4301 Series available?

A: Yes, samples can be ordered by contacting me or our Regional Marketing colleagues.

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